

C0603C153M5RECTU

Aliases (C0603C153M5REC7867)

ESD SMD Comm X7R, Ceramic, 0.015 uF, 20%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 0603



Click here for the 3D model.

Chip Size 0603 L 1.6mm +/-0.15mm W 0.8mm +/-0.15mm T 0.8mm +/-0.07mm	
W 0.8mm +/-0.15mm	
T $0.8mm \pm 1.007mm$	
0.01111/9-0.071111	
S 0.7mm MIN	
B 0.35mm +/-0.15mm	

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information	1
Series	ESD SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	4800 ug
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.015 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	20%
Voltage DC	50 VDC
ESD Level per AEC-Q200	16,000 V ESD Level
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	66.6667 GOhms

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